



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

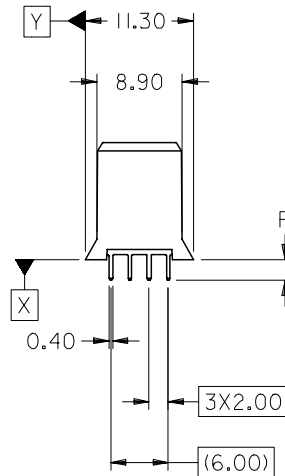
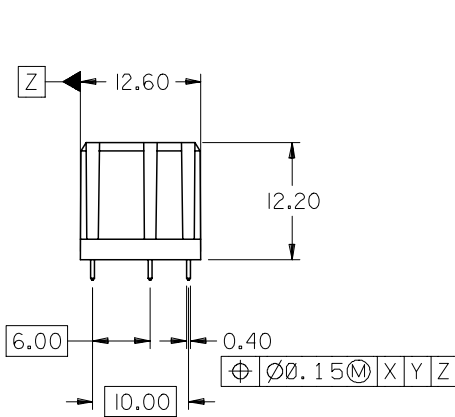
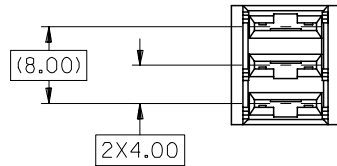
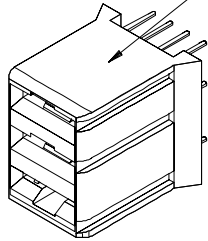
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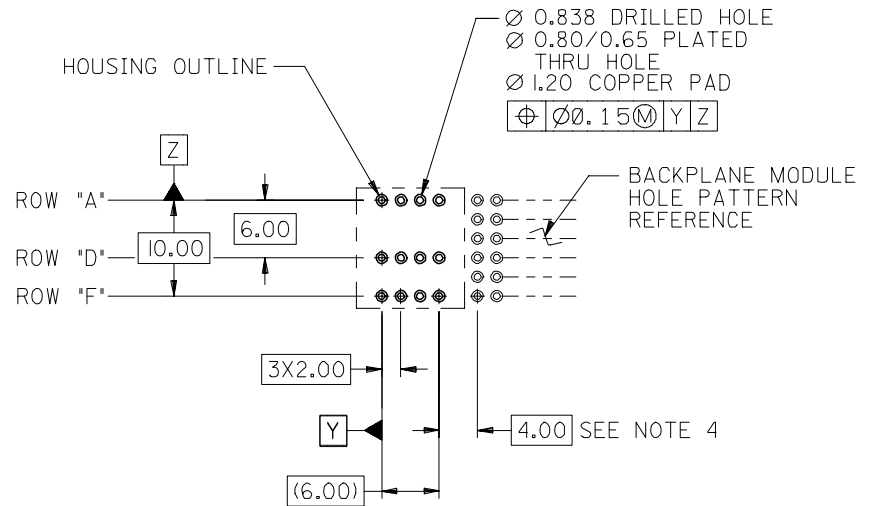
MATERIAL NUMBER	DIM "P" ±0.25
73659-0001	2.00
73659-0002	2.50
73659-0003	3.00
73659-0004	3.50

DATE CODE AND PART NUMBER ON THIS SURFACE OR SURFACE OPPOSITE.



NOTES:

- MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK  
TERMINAL - BERYLLIUM COPPER
- FINISH:  
0.75 MICROMETERS MINIMUM SELECTIVE GOLD (Au) IN MATING AREA  
2.50 MICROMETERS MINIMUM SELECTIVE TIN (Sn) IN TAIL AREA  
NICKEL (Ni) UNDERPLATE OVERALL.
- THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73670-9999.
- THIS DIMENSION MUST BE A MULTIPLE OF 4.00mm.
- DIMENSION ARE IN MILLIMETERS.



PCB LAYOUT: COMPONENT SIDE  
RECOMMENDED PCB THICKNESS: 1.57 MIN

REV	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
			mm	INCH	MM ONLY	DATE	TITLE		
		▽=0	4 PLACES	± ---	± ---	DRAWN BY	1996/12/10	SALES ASSY HDM BACKPLANE POWER MODULE WITH SOLDER TAILS	
		▽=0	3 PLACES	± ---	± ---	DATE	1996/12/10		
			2 PLACES	± 0.10	± ---	CHECKED BY	1996/12/10		
			1 PLACE	± 0.25	± ---	DATE	1996/12/10		
			ANGULAR ±1/2°		APPROVED BY	1996/12/10			
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.	DOCUMENT NO.		SHEET NO.	
					SEE TABLE	SDA-73659-000*		1 OF 1	
					SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			